

SEMICONDUCTORIM

September 1983 Revised February 1999

MM74HCU04 Hex Inverter

General Description

The MM74HCU04 inverters utilize advanced silicon-gate CMOS technology to achieve operating speeds similar to LS-TTL gates with the low power consumption of standard CMOS integrated circuits.

The MM74HCU04 is an unbuffered inverter. It has high noise immunity and the ability to drive 15 LS-TTL loads. The 74HCU logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs

are protected from damage due to static discharge by internal diode clamps to $\rm V_{CC}$ and ground.

Features

- Typical propagation delay: 7 ns
- Fanout of 15 LS-TTL loads
- Quiescent power consumption: 10 µA maximum at room temperature
- Low input current: 1 µA maximum

Ordering Code:

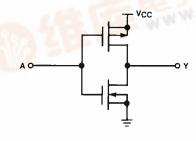
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Order Number	Package Number	Package Description
MM74HCU04M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
MM74HCU04SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCU04MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCU04N	N14A	14-Lead Plastic Dual-In-Lead Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP VCC A6 Y6 A5 Y5 A4 Y4 14 13 12 11 10 9 8 1 1 2 3 4 5 6 7 A1 Y1 A2 Y2 A3 Y3 GND Top View

Schematic Diagram



Absolute Maximum Ratings(Note 1)

(Note 2)

Supply Voltage (V_{CC}) -0.5 to +7.0V DC Input Voltage (V_{IN}) -1.5 to $V_{CC} + 1.5V$ DC Output Voltage (V_{OUT}) -0.5 to $V_{CC} + 0.5V$ Clamp Diode Current (I_{IK}, I_{OK}) ±20 mA DC Output Current, per pin (I_{OUT}) ±25 mA ±50 mA DC V_{CC} or GND Current, per pin (I_{CC}) -65°C to +150°C Storage Temperature Range (T_{STG})

Power Dissipation (P_D)

(Note 3) 600 mW S.O. Package only 500 mW

Lead Temperature (T_L)

(Soldering 10 seconds)

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V _{IN} , V _{OUT})			
Operating Temperature Range (T _A)	-40	+85	°C

Note 1: Absolute Maximum Ratings are those values beyond which dam-

Note 2: Unless otherwise specified all voltages are referenced to ground. Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		T _A = -40 to 85°C	T _A = -55 to 125°C	Units
Symbol			*CC	Тур	Guaranteed Limits			Onits
V _{IH}	Minimum HIGH Level		2.0V		1.7	1.7	1.7	V
	Input Voltage		4.5V		3.6	3.6	3.6	V
			6.0V		4.8	4.8	4.8	V
V _{IL}	Maximum LOW Level		2.0V		0.3	0.3	0.3	V
	Input Voltage		4.5V		0.8	0.8	0.8	V
			6.0V		1.1	1.1	1.1	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IL}$						
	Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	2.0	1.8	1.8	1.8	V
			4.5V	4.5	4.0	4.0	4.0	V
			6.0V	6.0	5.5	5.5	5.5	V
		V _{IN} = GND						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$						
	Output Voltage	$ I_{OUT} \leq 20 \; \mu A$	2.0V	0	0.2	0.2	0.2	V
			4.5V	0	0.5	0.5	0.5	V
			6.0V	0	0.5	0.5	0.5	V
		$V_{IN} = V_{CC}$						
		$ I_{OUT} \le 6.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} \le 7.8 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μΑ
	Current							
I _{CC}	Maximum Quiescent	V _{IN} = V _{CC} or GND	6.0V		2.0	20	40	μΑ
	Supply Current	$I_{OUT} = 0 \mu A$						
I _{IN}	Output Voltage Maximum Input Current Maximum Quiescent	$\begin{split} & I_{OUT} \leq 4.0 \text{ mA} \\ & I_{OUT} \leq 5.2 \text{ mA} \\ & V_{IN} = V_{IH} \\ & I_{OUT} \leq 20 \mu\text{A} \\ \\ & V_{IN} = V_{CC} \\ & I_{OUT} \leq 6.0 \text{ mA} \\ & I_{OUT} \leq 7.8 \text{ mA} \\ \\ & V_{IN} = V_{CC} \text{ or GND} \\ \\ & V_{IN} = V_{CC} \text{ or GND} \\ \end{split}$	6.0V 2.0V 4.5V 6.0V 4.5V 6.0V	5.7 0 0 0	5.48 0.2 0.5 0.5 0.26 0.26 ±0.1	5.34 0.2 0.5 0.5 0.33 0.33 ±1.0	0.2 0.5 0.5 0.4 0.4 ±1.0	ν ν ν ν

260°C

Note 4: For a power supply of 5V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage currents ${\rm rent}\; (I_{\rm IN},\,I_{\rm CC},\,{\rm and}\,I_{\rm OZ})\;{\rm occur}\,{\rm for}\,{\rm CMOS}\;{\rm at}\;{\rm the}\;{\rm higher}\,{\rm voltage}\;{\rm and}\;{\rm so}\;{\rm the}\;6.0{\rm V}\;{\rm values}\;{\rm should}\;{\rm be}\;{\rm used}.$

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units
t _{PHL} , t _{PLH}	Maximum Propagation		7	13	ns
	Delay				

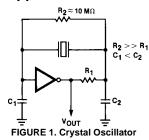
AC Electrical Characteristics

 $V_{CC} = 2.0 \text{V}$ to 6.0 V, $C_L = 50 \text{ pF}$, $t_r = t_f = 6 \text{ ns}$ (unless otherwise specified)

Symbol	Parameter	Conditions	V _{CC}	T _A =25°C		T _A =-40 to 85°C	T _A =-55 to 125°C	Units
			• 66	Typ Guaranteed Limits			Oilles	
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	49	82	103	120	ns
	Delay		4.5V	9.9	16	21	24	ns
			6.0V	8.4	14	18	20	ns
t _{TLH} , t _{THL}	Maximum Output Rise		2.0V	30	75	95	110	ns
	and Fall Time		4.5V	8	15	19	22	ns
			6.0V	7	13	16	19	ns
C _{PD}	Power Dissipation	(per gate)		90				pF
	Capacitance (Note 5)							
C _{IN}	Maximum Input			8	15	15	15	pF
	Capacitance							

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

Typical Applications



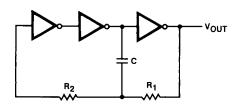
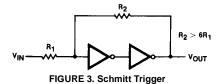
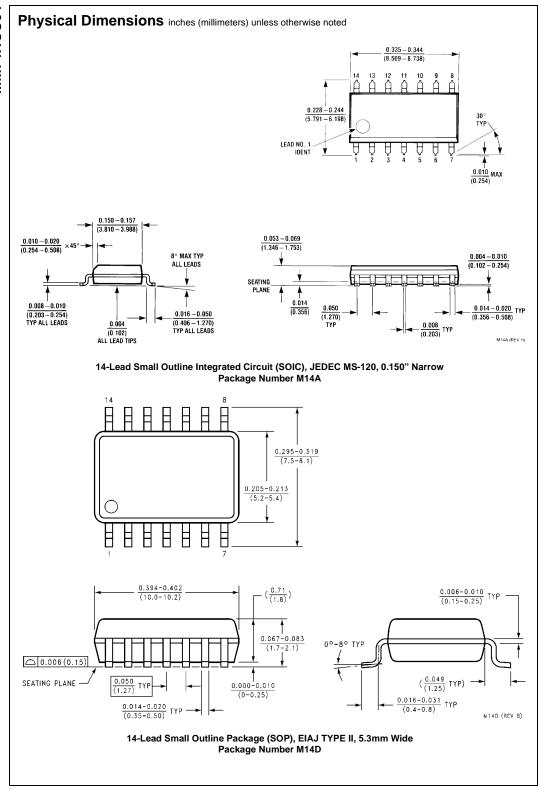


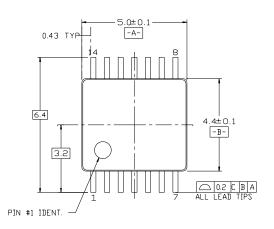
FIGURE 2. Stable RC Oscillator

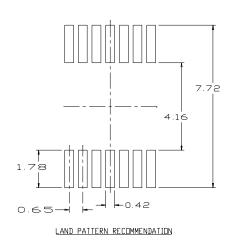


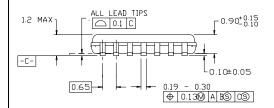


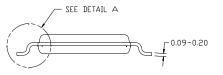
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE



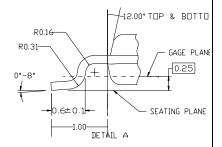






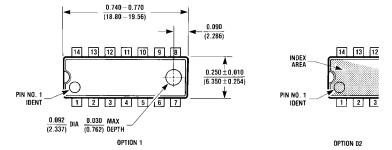
NOTES

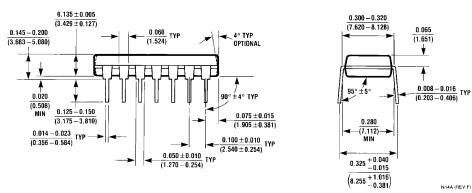
- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION ABJREF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

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